

DEC 29 2004

**TRANSMITTAL LETTER
(General - Patent Pending)**Docket No.
P0338DIV

In Re Application Of: Chun-Cheng Tsao and John Valliant

Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/693,310	10/24/2003	Shantese McDonald		3723	1505

Title: Method and Apparatus for Global Die Thinning and Polishing of Flip-Chip Packaged Integrated Circuits

COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Amendment Transmittal Letter
Amendment and Response to Office Action (15 pp)
Return Receipt Postcard

in the above identified application.

- ☒ No additional fee is required.
- ☐ A check in the amount of _____ is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 19-0603 as described below.
- ☐ Charge the amount of _____
- ☒ Credit any overpayment.
- ☒ Charge any additional fee required.
- ☐ Payment by credit card. Form PTO-2038 is attached.

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Deborah W. Wenocur
Signature

Dated: December 23, 2004

Deborah W. Wenocur, Reg. No. 40,221
Agent for Applicant
c/o Shelly Garrett
Credence Systems Corp.
1421 California Circle
Milpitas, CA 95035

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

December 24, 2004

(Date)

Deborah W. Wenocur

Signature of Person Mailing Correspondence

Deborah W. Wenocur

Typed or Printed Name of Person Mailing Correspondence

cc:

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AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Chun-Cheng Tsao and John Valliant

Docket No.

P0338DIV

Application No.

10/693,310

Filing Date

10/24/2003

Examiner

Shantese McDonald

Customer No.

Group Art Unit

3723

Confirmation No.

1505

Invention:  Method and Apparatus for Global Die Thinning and Polishing of Flip-Chip Packaged IntegratedCOMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

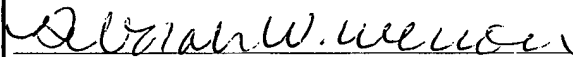
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	28 -	29 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	8 -	8 =	0	x \$86.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 19-0603
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.
- ☐ Payment by credit card. Form PTO-2038.

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Signature

Dated: December 23, 2004

Deborah W. Wenocur, Reg. No. 40,221
Agent for Applicant
c/o Shelly Garrett
Credence Systems Corp.
1421 California Circle
Milpitas, CA. 95035

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December 24, 2004

(Date)


Signature of Person Mailing Correspondence

Deborah W. Wenocur

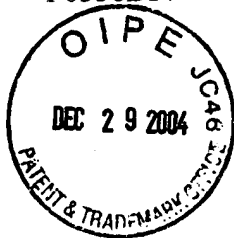
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P0338DIV



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William W. Wilson

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Applicant: Chung-Chen Tsao and John Valliant) Grp Art Unit: 3723
)
Assignee: Credence Systems Corporation) Ex: Shantese McDonald
)
Serial Number: 10/693,310)
)
Filed: October 24, 2003)
)
For: METHOD AND APPARATUS FOR)
BACKSIDE DIE THINNING AND)
POLISHING OF PACKAGED)
INTEGRATED CIRCUITS)
)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir,

AMENDMENT AND RESPONSE TO OFFICE ACTION

This is in response to the Office Action dated December 1, 2004.

Please amend the instant application as follows: